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## **ACCEPTED MANUSCRIPT**

# Influence of Surface Preparation and Cleaning on the Passivation of Boron Diffused Silicon Surfaces for High Efficiency Photovoltaics

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**Keywords:** wafer cleaning, surface preparation, surface passivation, silicon, aluminum oxide, silicon nitride

#### **Abstract:**

The use of proper surface preparation and cleaning methods for Si wafers prior to the deposition of passivation layers is essential to minimize surface recombination and realize high efficiencies (>20%) in crystalline Si photovoltaic cells. In this work, the influence of wafer cleaning on the quality of surface passivation achievable for boron-doped emitters was investigated, including the use of different combinations of HCl, HF, HNO<sub>3</sub>, and ozonated deionized water (DIO<sub>3</sub>). These different surface preparations and cleaning sequences were performed on undiffused and boron diffused n-type Cz Si wafers, followed by the deposition of either silicon nitride (SiN<sub>x</sub>) or an aluminum oxide film capped with SiN<sub>x</sub> (Al<sub>2</sub>O<sub>3</sub>/SiN<sub>x</sub> stack). Additionally, both planar and anisotropically textured wafers were used. Injection-level dependent photoconductance measurements and calibrated photoluminescence imaging were performed on symmetrical boron diffused samples based on the different cleaning processes and passivation materials described

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